PowerSpector

FDAz FDLz FDA FDL

Desktop Automatic Optical Inspection systems

√ Automatic Optical Inspection of PCB assemblies.................. — *test your PCB's optically and replace manual inspection*

√ Inspects: .... — *use inspection in all stages of the production process*
  - Components: SMT & THT (missing, type, polarity, offset, text, colors, etc.)
  - Solder Paste and CIP (Components in Paste; pre-reflow)
  - Soldering: Post Reflow, Post Wave, Selective, Manual

√ Flexible classification and reporting scenarios........................ — *integrate AOI efficiently in your existing operations and factory lay-out*

√ In Medium and XXL size PCB's versions .... — *choose the best hardware configuration for your processes*

√ Multi-color 3 angle lighting with Line Source Coaxial Lighting and Meniscus Profiler — *reliable solder joint meniscus and pad surface analysis (to find meniscus and paste printing defects)*

√ Line Sourced DOAL(Direct On Axis Lighting) coaxial lighting system with high resolution Telecentric Optics……………… — *inspect solder joints without shadow effects from tall components nearby and accurate inspection model building*

√ Low Noise Large CCD High Speed 24 bit Color Camera — *find defects easier including printing defects on Gold or Cu plated PCB's*

√ Synthetic Imaging and Spectral Analysis................................ — *powerful algorithms to achieve an optimal balance between defect detection and false reject levels in shortest time*

√ Triple use of side camera's (FDA and FDAz models only) ..... — *Use for automatic inspection, classification and repair*

√ Prototype mode for 1st off inspection.................................... — *program in minutes to verify your production line is set-up correctly before starting full production*

√ In height adjustable optical head (FDLz and FDAz models only) — *Compensate for PCB warp and adapt to tall component and sandwich assemblies*

√ Compact footprint design .... — *maximize factory floor efficiency*
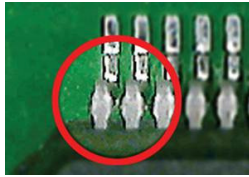
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Hardware and Software Features

High grade Telecentric Lens
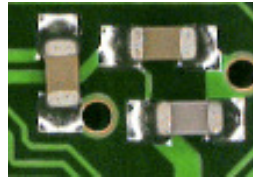Parallel image over the whole sensor/lens Field of View— No parallax effect
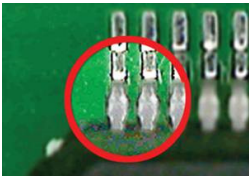
Telecentric Lens   Conventional Lens

Large pixel image capturing sensor
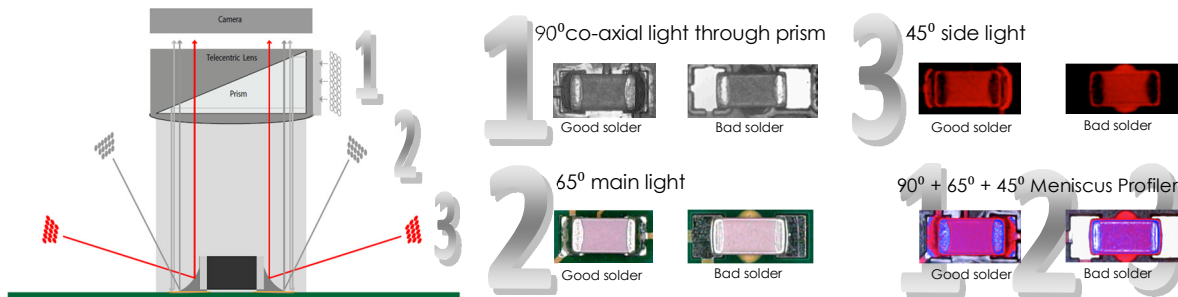18.8µm^2 pixel size — less noise — smooth and detailed image— great dynamic range

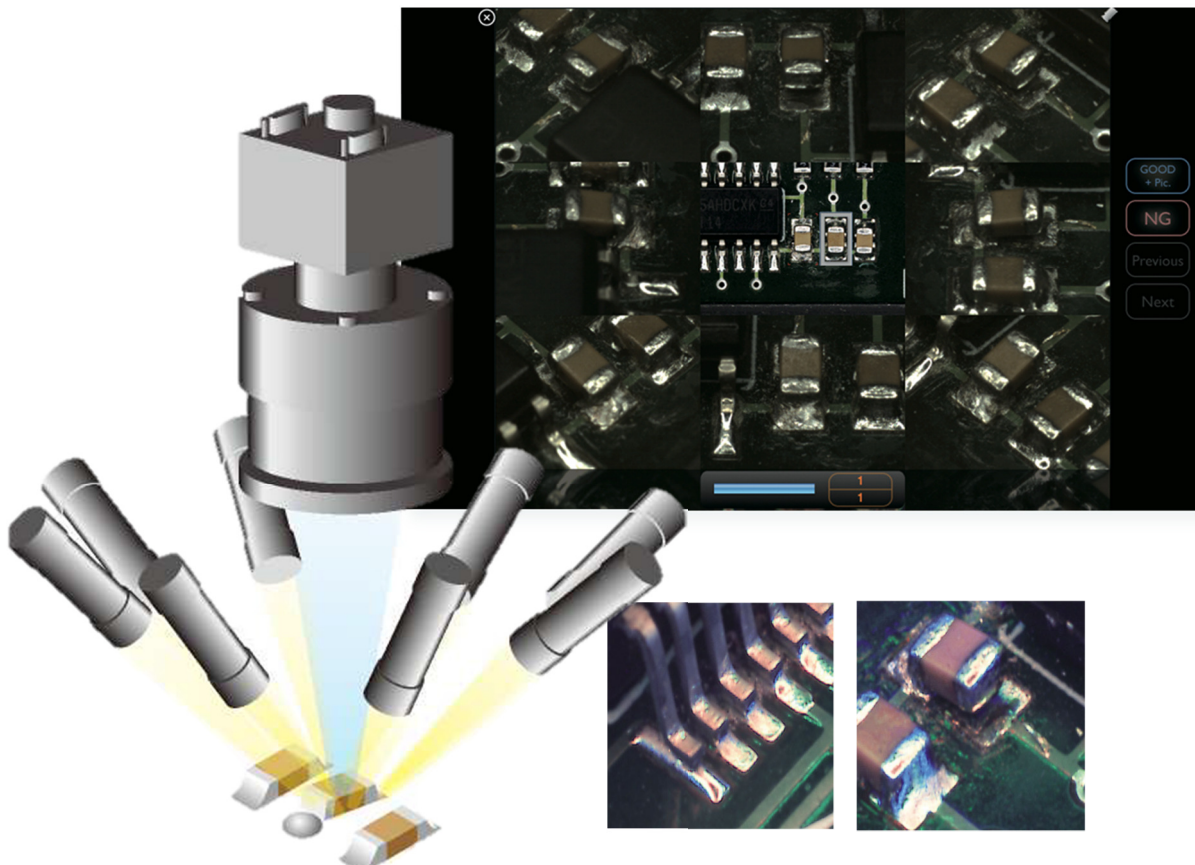High dynamics sensor   Conventional sensor

Omnidirectional multi angle, multi color LED lighting
Optimal light no matter component direction — 3D color profile of solder meniscus — Reliable defect decision by the software — Decide Good Solder, No Solder, Lack of Solder and Too much solder for SMT and THT solder joints

Camera
Telecentric Lens
Prism

1 90^{0}co-axial light through prism
Good solder   Bad solder

3 45^0 side light
Good solder   Bad solder

2 65^0 main light
Good solder   Bad solder

90^0 + 65^0 + 45^0 Meniscus Profiler
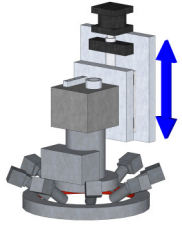Good solder   Bad solder

8x Angular Side Sensors (Only available for FDA and FDAz models)
Simultaneously operating, multiplexed side view sensors with CameraLink interface — 45/45 arrangement — Triple use: Active automatic inspection, classification and repair — clear 9 angles defect review — high magnification 50x (10µm/pixel) — Full Color — Auto highlight — Large sensor pixels — 9 view images also in backup database

GOOD + Pic.
NG
Previous
Next

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PowerSpector FDAz FDLz FDA FDL
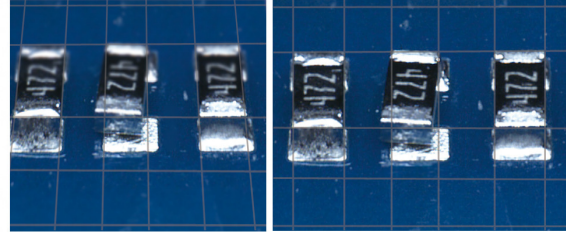
Hardware and Software Features — Continued

In Height Adjustable Optical Head (Only available for FDLz and FDAz models)
In Z-Axis moving Top Camera, Light and Side View cameras — Adaption to any PCB Thickness — PCB Warp Compensation — Inspection of PCB's with very tall components — Reliable text and/or polarity inspection on tall components — Inspection of "Sandwich" assemblies without need of jigs and multiple inspections

Without Shift&Tilt   Shift&Tilt

Shift & Tilt Side View lenses (FDA and FDAz models only)
Distortion free side images across whole FoV. Every point on the PCB within the FoV has same distance to the capturing sensor despite the angle of the optics
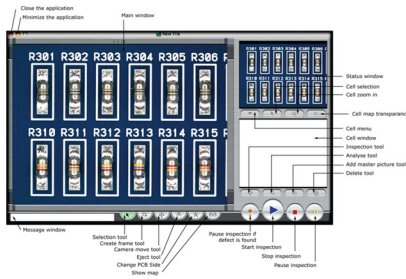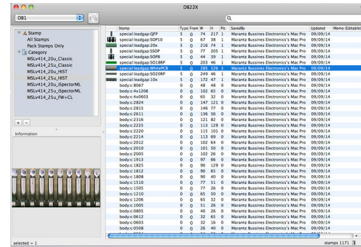
Clean User Interface
Intuitive user interface — Control everything from one screen — Easy step-by-step teaching, programming and debugging environment
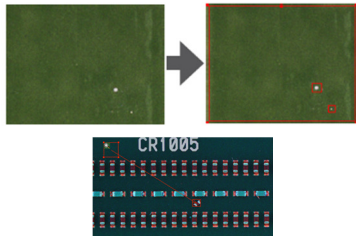
Short Programming Time
Use of components database — Library management tools — Offline debugging — Inspection parameters of components unique selectable per program , per part
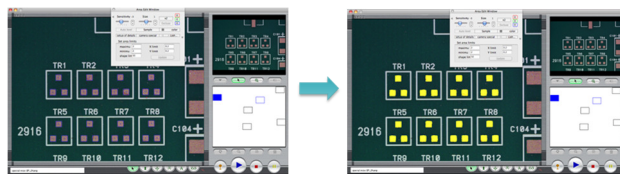
Extra Part checking
Inspect areas not covered by CAD data — Detect components and solder balls

2D SPI, and CIP (Component In Paste) inspections built-in
Import of Gerber and CAD data — Check shape, offset, lack and smearing of solder paste

Automatic IC/QFP Parameter detection
Auto detection of pitch size, pin length, pin width, number of pins — program 1 pin and the others are automatically programmed
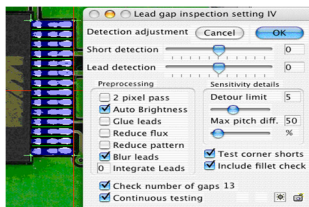
Combined Pattern Matching and Condition based algorithms
Condition based detection, great for solder related errors — Pattern Matching for all kinds of others
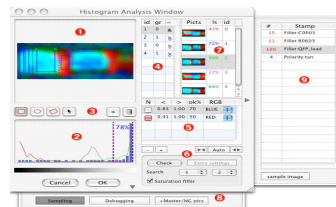
Special THT inspection algorithms
Detects all type of THT solder errors; pin availability, no solder, lack of solder, too much solder, bad shape solder, solder attached only to pin and circumferential wetting problems — Always inspect around pin also when pin is not in center of hole

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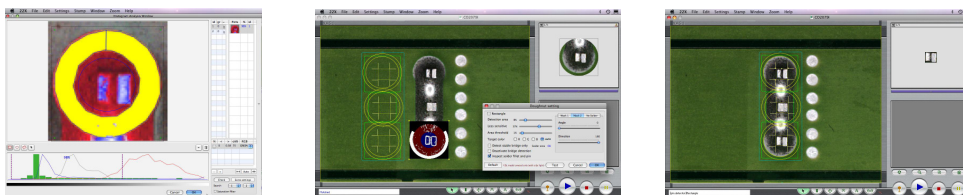
Desktop

PowerSpector

FDAz 350, 520, 650, 800

Desktop Series Specifications	PowerSpector FDAz 350	PowerSpector FDAz 520	PowerSpector FDAz 650	PowerSpector FDAz 800
Maximum PCB Size	350x250mm (13.8" x 9.8")	520x460mm (20.5"x 18.1")	650x550mm (25.6" x 21.6")	800x550mm (31.5"x21.6")
Characteristics				
Product type	Automatic Optical Inspector			
In-line/Off-line	Off-Line			
Camera movement	X Direction	X + Y Direction	X + Y Direction	X + Y Direction
PCB movement	Moving in Y	Stationary	Stationary	Stationary
PCB fixation	Direct Loading	Direct Loading	Manual Drawer Options: Motorized Drawer, Transverse loader	Manual Drawer Options: Motorized Drawer, Transverse loader
Parts inspection	Presence, Polarity, Offset, Correctness, Soldering			
Printing/paste inspection	Offset, Smearing, Bridges, Uniformity			
Image Processing	Synthetic Imaging, Spectral Analysis, Greyscale limits			
Image Parameters	Brightness, Hue, Saturation via Filters			
Camera type	Digital *color* w/CameraLink			
Camera Field Of View/Resolution	36x20mm/18.75μm or 19.2x10.8mm/10μm			
Lens	Telecentric lens with built in prism for DOAL Lighting			
Lighting system	Omnidirectional Triple LED rings: Side, Main, Line Sourced DOAL Diffused On Axis Lighting (Coaxial))			
Specifications				
Minimum inspection component size	01005" (0.4x0.2mm)(10μm resolution)			
Positioning accuracy	Pixel related Feedback Loop			
Component clearance (top)	30mm (1.2")			
Side Cameras	8x Digital *color* w/CameraLink in 45/45 orientation			
Z-Axis movement range	60mm (2.4")			
Component clearance (bottom)	70mm (2.8")	70mm (2.8")	70mm (2.8")	70mm (2.8")
Maximum PCB Size	350x250mm (13.8" x 9.8")	520x460mm (20.5"x 18.1")	650x550mm (25.6" x 21.6")	800x550mm (31.5"x21.6")
Movement speed	720mm/s			
Inspection capacity typical	1500ppm			
Electrical Requirement	100-240 VAC / 150W			
Interfacing				
Control PC type	Apple Mac (Intel) with Mac OSX			
Control interface	USB			
Data interface	CameraLink			
General				
Operating temperature	15-30 deg. C(60-90 deg. F)			
Operating humidity	15-80 % RH			
External size	W736 x D874 x H450 (29.0" x 34.4" x 7.7")	W1110 x D1040 x H600 (43.7" x 50" x 23.6")	W940 x D1015 x H500 (37.0" x 34.0" x 19.7")	W1157 x D1015 x H500 (45.55" x 34.0" x 19.7")
Weight	65kg (143lbs)	160kg (350lbs)	110kg (243lbs)	120kg (265lbs)

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Desktop

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FDL   350, 520, 650, 800

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Lighting system	Omnidirectional Triple LED rings: Side, Main, Line Sourced DOAL Diffused On Axis Lighting (Coaxial))			
Specifications				
Minimum inspection component size	01005" (0.4x0.2mm)(10µm resolution)			
Positioning accuracy	Pixel related Feedback Loop			
Component clearance (top)	50mm (2.0")			
Component clearance (bottom)	70mm (2.8")	70mm (2.8")	70mm (2.8")	70mm (2.8")
Maximum PCB Size	350x250mm (13.8" x 9.8")	520x460mm (20.5"x 18.1")	650x550mm (25.6" x 21.6")	800x550mm (31.5"x21.6")
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